

Photocoupler LTV-357T series

1. DESCRIPTION

1.1 Features

- Current transfer ratio (CTR : MIN. 50% at I_F = 5mA, V_{CE} = 5V)
- High input-output isolation voltage (Viso = 3,750Vrms)
- High collector-emitter voltage (V_{CEO} = 35V)
- SOP-4 package
- Mini-flat package : 2.0mm profile : LTV-357T series

 Safety approval UL 1577
 VDE DIN EN60747-5-5 (VDE 0884-5) , CSA CA5A
 CQC GB4943.1-2011/ GB8898-2011
 FIMKO/DEMKO/SEMKO/NEMKO

- RoHS Compliance All materials be used in device are followed EU RoHS directive (No.2002/95/EC).
- ESD pass HBM 8000V/ MM2000V/ CDM2000V
- MSL class1

1.2 Applications

- Hybrid substrates that require high density mounting.
- Programmable controllers
- System appliance, measuring instruments

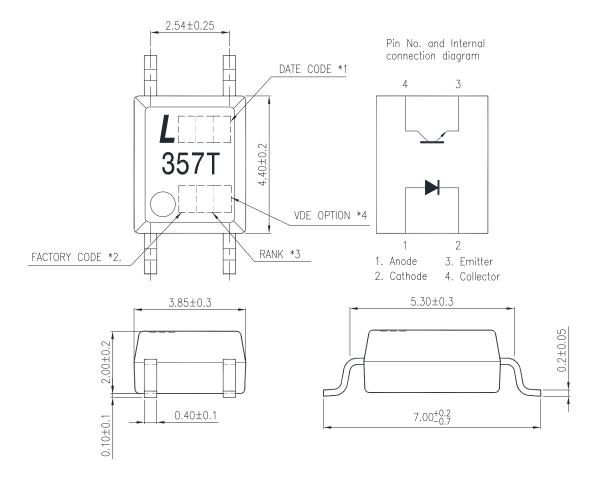
1/12



Photocoupler LTV-357T series

2. PACKAGE DIMENSIONS

2.1 LTV-357T series



Notes :

- 1-digit year code, Example : 2010 = A
 2-digit work week ranging from '01' to '53'
- 2. Factory identification mark shall be marked (W: China -CZ, X: China -TJ)
- 3. Rank shall be or shall not be marked.
- 4. "
 "indicates halogen free option.
- 5. "4" or" V" for VDE option.

*All dimensions in millimeters.

2/12

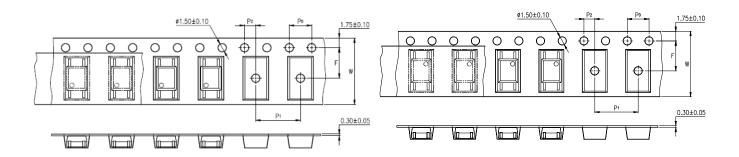


Photocoupler LTV-357T series

3. TAPING DIMENSIONS

3.1 LTV-357T-TP

3.2 LTV-357T



Description	Symbol	Dimension in mm (inch)
Tape wide	W	12±0.3 (0.472)
Pitch of sprocket holes	P ₀	4±0.1 (0.157)
Distance of compartment	F	5.5±0.1 (0.217)
Distance of compartment	P ₂	2±0.1 (0.079)
Distance of compartment to compartment	P ₁	8±0.1 (0.315)

3.3 Quantities Per Reel

Package Type	LTV-357T series
Quantities (pcs)	3000

3/12



Photocoupler LTV-357T series

4. RATING AND CHARACTERISTICS

4.1 Absolute Maximum Ratings at Ta=25℃

	Parameter	Symbol	Rating	Unit
	Forward Current	I _F	50	mA
lanut	Reverse Voltage	V _R	6	V
Input	Power Dissipation	Р	70	mW
	Junction Temperature	TJ	125	°C
	Collector - Emitter Voltage	V _{CEO}	35	V
	Emitter - Collector Voltage	V _{ECO}	6	V
Output	Collector Current	Ι _C	50	mA
	Collector Power Dissipation	Pc	150	mW
	Junction Temperature	TJ	125	°C
	Total Power Dissipation	P _{tot}	170	mW
1.	Isolation Voltage	V _{iso}	3750	V _{rms}
	Operating Temperature	T _{opr}	-55 ~ +110	°C
	Storage Temperature	T _{stg}	-55 ~ +150	°C
2.	Soldering Temperature	T _{sol}	260	°C

1. AC For 1 Minute, R.H. = 40 ~ 60%

Isolation voltage shall be measured using the following method.

- Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The isolation voltage tester with zero-cross circuit shall be used.
- (3) The waveform of applied voltage shall be a sine wave.
- 2. For 10 Seconds

4/12



Photocoupler LTV-357T series

4.2 ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C

	Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
	Forward Voltage	V _F	—	1.2	1.4	V	I _F =20mA
Input	Reverse Current	I _R	_	_	10	μA	V _R =4V
	Terminal Capacitance	Ct	_	30	250	pF	V=0, f=1KHz
	Collector Dark Current	I _{CEO}	_	_	100	nA	V _{CE} =20V, I _F =0
Output	Collector-Emitter Breakdown Voltage	BV _{CEO}	35			V	I _C =0.1mA, I _F =0
	Emitter-Collector Breakdown Voltage	BV _{ECO}	6	_		V	I _E =10μΑ, I _F =0
	Collector Current	Ι _C	2.5	—	30	mA	I _F =5mA
	1. Current Transfer Ratio	CTR	50	—	600	%	V _{CE} =5V
	Collector-Emitter Saturation Voltage	V _{CE(sat)}	_		0.2	V	I _F =20mA I _C =1mA
TRANSFER CHARACTERISTICS	Isolation Resistance	R _{iso}	5×10 ¹⁰	1×10 ¹¹		Ω	DC500V, 40 ~ 60% R.H.
	Floating Capacitance	Cf	—	0.6	1	pF	V=0, f=1MHz
	Response Time (Rise)	tr	—	4	18	μs	V _{CE} =2V,
	Response Time (Fall)	tf		3	18	μs	I _C =2mA R∟=100Ω,

1. CTR =
$$\frac{I_{\rm C}}{I_{\rm F}} \times 100\%$$





Photocoupler LTV-357T series

5. RANK TABLE OF CURRENT TRANSFER RATIO (CTR)

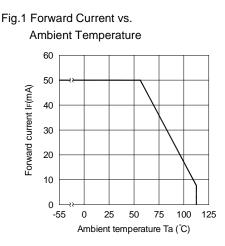
CTR Rank	Min	Max	Condition
A	80	160	
В	130	260	
С	200	400	I _F =5mA, V _{CE} =5V, Ta=25°C
D	300	600	$r = 3 m A, v_{CE} = 3 v, ra = 23 C$
E	50	150	
A or B or C or D or No mark	50	600	

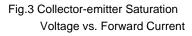


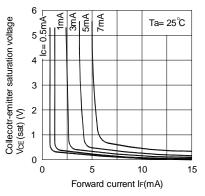


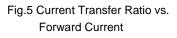
Photocoupler LTV-357T series

6. CHARACTERISTICS CURVES (TYPICAL PERFORMANCE)









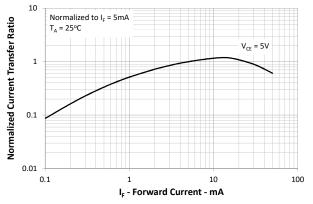


Fig.2 Collector Power Dissipation vs.

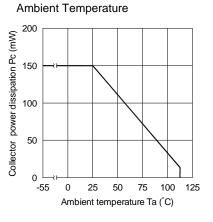


Fig.4 Forward Current vs. Forward Voltage

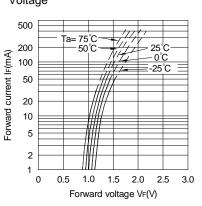
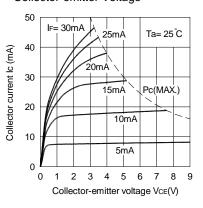


Fig.6 Collector Current vs. Collector-emitter Voltage



7/12



Photocoupler LTV-357T series

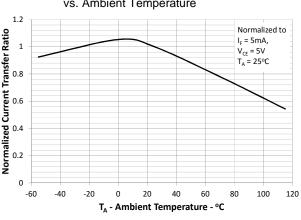


Fig.7 Relative Current Transfer Ratio vs. Ambient Temperature



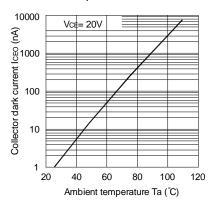
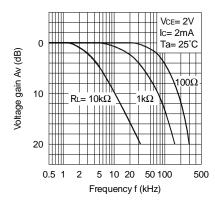


Fig.11 Frequency Response





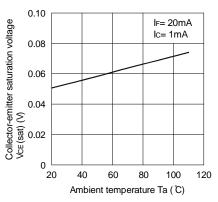
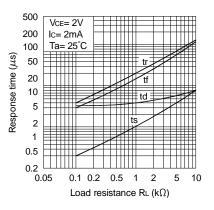
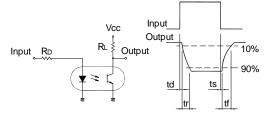


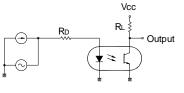
Fig.10 Response Time vs. Load Resistance



Test Circuit for Response Time



Test Circuit for Frequency Response



8/12

Downloaded from Arrow.com.



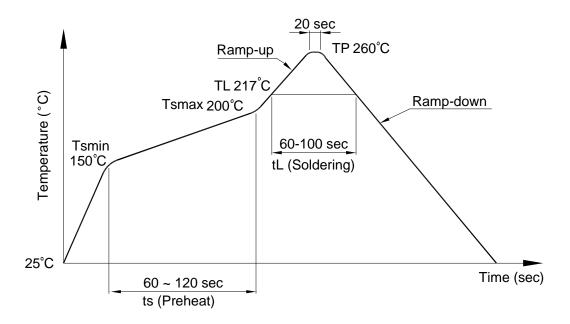
Photocoupler LTV-357T series

7. TEMPERATURE PROFILE OF SOLDERING

7.1 IR Reflow soldering (JEDEC-STD-020C compliant)

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.

Profile item	Conditions
Preheat	
- Temperature Min (T _{Smin})	150°C
- Temperature Max (T _{Smax})	200°C
- Time (min to max) (ts)	90±30 sec
Soldering zone	
- Temperature (T_L)	217°C
- Time (t _L)	60 ~ 100 sec
Peak Temperature (T _P)	260°C
Ramp-up rate	3°C / sec max.
Ramp-down rate	3~6°C / sec



9/12



Photocoupler LTV-357T series

7.2 Wave soldering (JEDEC22A111 compliant)

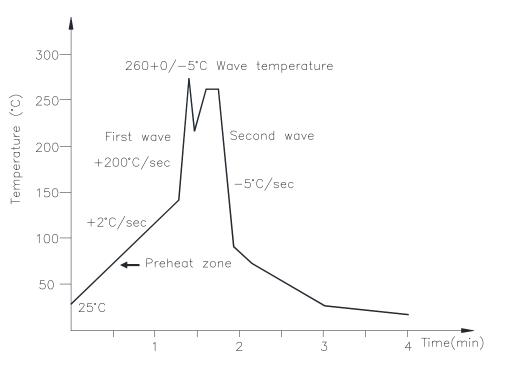
One time soldering is recommended within the condition of temperature.

Temperature: 260+0/-5°C

Time: 10 sec.

Preheat temperature:25 to 140°C

Preheat time: 30 to 80 sec.



7.3 Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

Temperature: 380+0/-5°C

Time: 3 sec max.

10/12

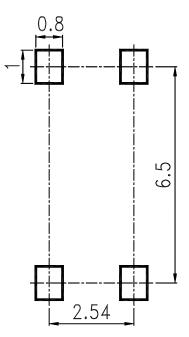




Photocoupler LTV-357T series

8. RRECOMMENDED FOOT PRINT PATTERNS (MOUNT PAD)

Unit: mm







Photocoupler LTV-357T series

9. NAMING RULE

LTV-357T-(1)-(2)-G
DEVICE PART NUMBER
Please refer to orientation of taping on Page P3
(2) CTR RANK Please refer to Page P6 (3) Halogen free option
Example : LTV-357T-TP-A-G
LTV 357T (1)(2)-V-G
LTV 357T (1)(2)-V-G
DEVICE PART NUMBER
DEVICE PART NUMBER

10. NOTES

- LiteOn is continually improving the quality, reliability, function or design and LiteOn reserves the right to make changes without further notices.
- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.
- When requiring a device for any "specific" application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.
- The contents described herein are subject to change without prior notice.
- Immerge unit's body in solder paste is not recommended.

12/12